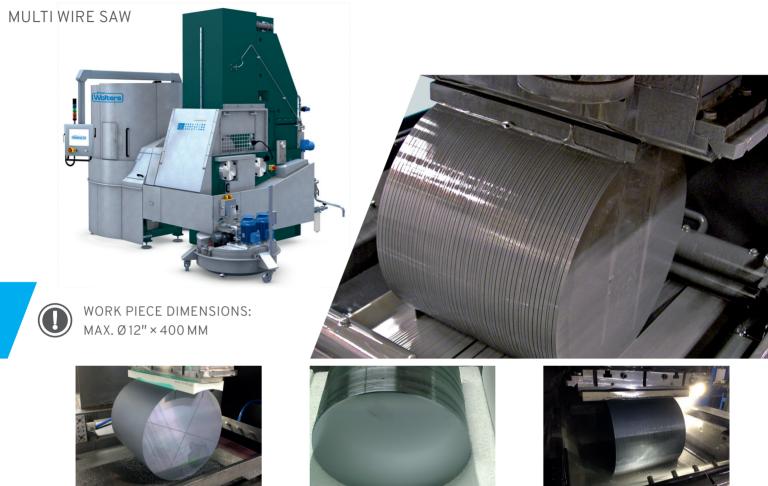




DS 261



12" WAFER WITH HIGHEST SURFACE QUALITY



Compact and solid construction





Lowest warp, waviness and TTV values



Excellent results in nano-topology

PRECISE SLURRY WIRE SAW FOR HIGH END INDUSTRIES

enhancing surface quality





HIGHLIGHTS DS 261

- New operator guided HMI and electrical system on Series 6 release
- Wide range of applications: silicon, quartz, gallium arsenide and other hard & brittle material in different dimensions
- Proven slurry technology and DW ready
- Optimized slurry temperature control
- 60-step recipe enables optimal process tuning
- Automated cutting process and perfect accessability
 Optional work piece orientation



Robust design for lowest warp



Perfect alignment for highest precision



Easy operation for higher yield

TECHNICAL DATA	DS 261 FEATURES
Web length [mm]	410
Max. work piece dimensions [mm]	Ø 305 mm × 400 (Ø 18″ on request)
Wire speed [m/s]	15 (900 m/min)
Wire acceleration [m/s²]	2.5 (< 6.5 s)
Min. wire diameter [µm]	120
Max. wire tension [N]	50
Wire guide roller axes distance [mm]	600
Cutting fluid	Slurry
Slurry tank [I]	175
Machine dimensions $[L \times W \times H]$ [mm]	2980 × 4120 × 3340
Machine weight [kg]	12000

GET IN TOUCH WITH US TODAY TOGETHER WE WILL FIND A SOLUTION FOR YOUR REQUIREMENTS

LAPMASTER WOLTERS GMBH

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